



DMG3415UFY4Q

Product Summary

| V _{(BR)DSS} | R _{DS(ON)} max | I _D max T _A = +25°C |
|----------------------|--------------------------------|--|
| | 39mΩ @ V _{GS} = -4.5V | -2.5A |
| -16V | 52mΩ @ V _{GS} = -2.5V | -2.1A |
| | 65mΩ @ V _{GS} = -1.8V | -1.8A |

Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Backlighting
- Power Management Functions
- DC-DC Converters

P-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Up To 3kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

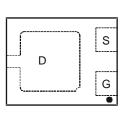
- Case: X2-DFN2015-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)



Top View

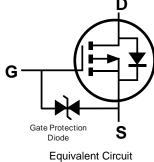


Bottom View



Internal Schematic

(Top View)



Ordering Information (Note 5)

| Part Number | | Case | Packaging | | | | |
|-------------|---|--------------|-------------------|--|--|--|--|
| | DMG3415UFY4Q-7 | X2-DFN2015-3 | 3,000/Tape & Reel | | | | |
| Notes: | | | | | | | |
| | 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" | | | | | | |

and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

| • | 34P | |
|---|-----|--|
| | YM | |

34P = Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

| Date Code Rey | | | | | | | | | | | | |
|---------------|------|-----|-----|------|------|-----|-----|------|------|-----|-----|------|
| Year | 2009 | | ~ | 2015 | 2016 | 20 |)17 | 2018 | 2019 | 20 | 20 | 2021 |
| Code | W | | ~ | С | D | | E | F | G | ŀ | - | Ι |
| Month | Jan | Feb | Mar | Apr | Мау | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|---|------------------|---|------------------|--------------|---|
| Drain-Source Voltage | V _{DSS} | -16 | V | | |
| Gate-Source Voltage | | | V _{GSS} | ±8 | V |
| Continuous Drain Current (Note 7) V _{GS} = -4.5V | Steady State | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | ID | -2.5 -2.2 | А |
| Pulsed Drain Current (Note 7) | | | I _{DM} | -12 | А |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit | |
|--|---------------------|----------------------------------|-------------|------|
| Total Power Dissipation (Note 6) | | PD | 0.65 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | $R_{	extsf{	heta}JA}$ | 197 | °C/W |
| Total Power Dissipation (Note 7) | | PD | 1.35 | W |
| Thermal Resistance, Junction to Ambient (Note 7) | $R_{	ext{	heta}JA}$ | 95 | °C/W | |
| Thermal Resistance, Junction to Case (Note 7) | | $R_{	ext{	heta}JC}$ | 22 | |
| Operating and Storage Temperature Range | | T _{J.} T _{STG} | -55 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.) Characteristic **Test Condition** Symbol Min Max Unit Тур OFF CHARACTERISTICS (Note 8) Drain-Source Breakdown Voltage -16 V $V_{GS} = 0V, I_D = -250 \mu A$ BV_{DSS} Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$ -1.0 μA $V_{DS} = -16V, V_{GS} = 0V$ IDSS ____ ±10 μΑ $V_{GS} = \pm 8V, V_{DS} = 0V$ Gate-Source Leakage Igss ____ ±500 'nΑ $V_{GS} = \pm 5V, V_{DS} = 0V$ ON CHARACTERISTICS (Note 8) Gate Threshold Voltage V -0.3 -0.55 -1.0 $V_{DS} = V_{GS}$, $I_D = -250 \mu A$ VGS(TH) 31 39 $V_{GS} = -4.5V, I_D = -4.0A$ 40 52 mΩ V_{GS} = -2.5V, I_D = -3.5A Static Drain-Source On-Resistance RDS(ON) 51 65 V_{GS} = -1.8V, I_D = -2.0A Forward Transfer Admittance |Y_{fs}| 7.9 S $V_{DS} = -5V, I_D = -2.5A$ **DYNAMIC CHARACTERISTICS (Note 9)** Input Capacitance Ciss 282 pF $V_{DS} = -10V, V_{GS} = 0V$ Coss Output Capacitance 152 pF f = 1.0MHzReverse Transfer Capacitance pF 38 Crss ____ 250 Gate Resistance Rg Ω $V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$ Total Gate Charge Qg 10 nC Q_{gs} Gate-Source Charge 1.5 nC $V_{GS} = -4.5V, V_{DS} = -10V, I_D = -4A$ Gate-Drain Charge 2.4 nC Q_{gd} ____ ____ Turn-On Delay Time 79 ns t_{D(ON)} ____ ____ Turn-On Rise Time 175 ns $V_{DS} = -10V, V_{GS} = -4.5V,$ t_R ____ ____ Turn-Off Delay Time 885 $R_{D} = 2.5\Omega, R_{G} = 3.0\Omega$ ____ ____ ns t_{D(OFF)} Turn-Off Fall Time 568 tc ns

Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

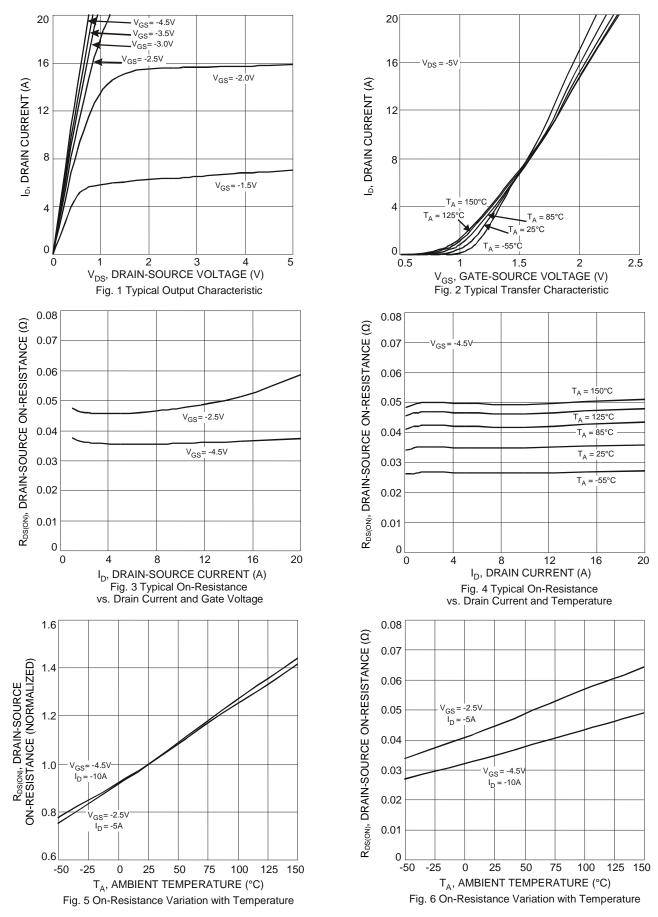
7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

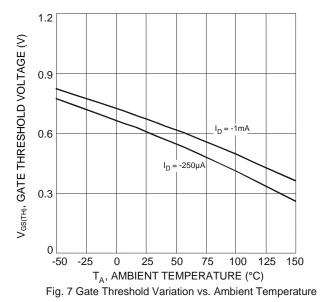


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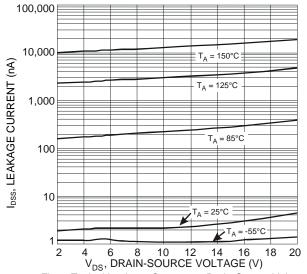
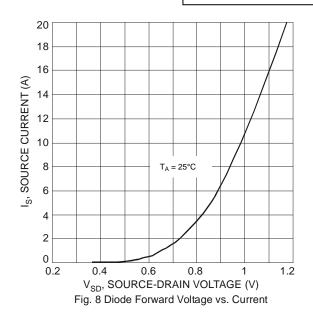
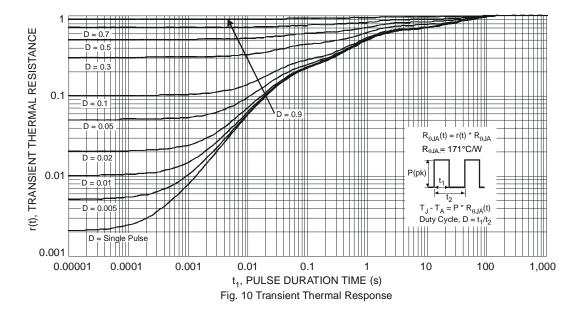


Fig. 9 Typical Leakage Current vs. Drain-Source Voltage



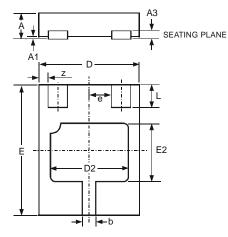




Package Outline Dimensions

Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.

X2-DFN2015-3

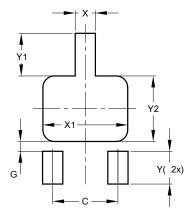


| X2-DFN2015-3 | | | | | | | |
|----------------------|------|-------|-------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 1 | 0.40 | - | | | | |
| A1 | 0 | 0.05 | 0.02 | | | | |
| A3 | - | - | 0.13 | | | | |
| b | 0.20 | 0.30 | 0.25 | | | | |
| D | 1.45 | 1.575 | 1.5 | | | | |
| D2 | 1.00 | 1.20 | 1.10 | | | | |
| е | - | - | 0.50 | | | | |
| Е | 1.95 | 2.075 | 2.00 | | | | |
| E2 | 0.70 | 0.90 | 0.80 | | | | |
| L | 0.25 | 0.35 | 0.30 | | | | |
| z | - | - | 0.125 | | | | |
| All Dimensions in mm | | | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.

X2-DFN2015-3



| X2-DFN2015-3 | | | | |
|--------------|------------------|--|--|--|
| Dimensions | Value (in mm) | | | |
| С | 1.000 | | | |
| G | 0.150 | | | |
| Х | 0.310 | | | |
| X1 | 1.300 | | | |
| Y | 0.500 | | | |
| Y1 | 0.650 | | | |
| Y2 | 1.000 | | | |



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